

Printed Electronics Insights – Free seminars by OE-A, Nov. 19/20, 2025



Flexible and Printed Electronics: Applications and technologies

Date: Wednesday, November 19,
Time: 2025 14:15 - 16:30 h
Venue: Innovation Forum, Hall B2.441

Moderation: Dr. Klaus Hecker, Managing Director, OE-A

- » 14:15 h Introduction to Printed Electronics
Dr. Klaus Hecker, Managing Director, OE-A (DE)
- » 14:25 h Printed Electronics – current applications and future trends
Dr. Alain Schumacher, CTO, IEE (LU)
- » 14:45 h Manufacturing and applications of large-area LED foils
Dr. Ashok Sridhar, CEO & Co-founder, TracXon (NL)
- » 15:05 h Hybrid electronics compared to conventional PCBs: their advantages and challenges
Jonas Deitschun, Head of Department Advanced Printing Technologies, Fraunhofer IFAM (DE)
- » 15:25 h Pilot services for supporting and accelerating flexible electronics R&D
Prof. Jukka Hast, Research Manager, VTT (FI)
- » 15:45 h Debonding on demand tapes for rework, repair, and recycling in electronics
Tom Schümchen, Innovation Manager, Lohmann (DE)
- » 16:05 h Empowering Scalable Innovation in Functional Surfaces
Fabien Resweber, Business Development Manager, Armor Smart Films (FR)
- » 16:25 h Summary & Adjourn
Dr. Klaus Hecker, Managing Director, OE-A (DE)
- » 16:30 h End

For more information visit the **OE-A / LOPEC in hall B2, booth 453
and discover the world of flexible and printed electronics.**

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Flexible and Printed Electronics: Materials, processes and reliability

Date: Thursday, November 20, 2025
Time: 14:15 - 16:50 h
Venue: Innovation Forum, Hall B2.441

Moderation: Raswanth Sendhil Sasikala, Project Manager, OE-A

- » 14:15 h Introduction to Printed Electronics
Raswanth Sendhil Sasikala, Project Manager, OE-A (DE)
- » 14:25 h Functionalizing 3D parts with precision: pad printing as a scalable alternative manufacturing technology
Anna Ryzhova, Business Development Manager EIMEA, Henkel (DE)
- » 14:45 h Rebuilding the EU PCB industry by moving from chemical etching to additive printing of copper inks
Dr. Ofer Shochet, CEO & Co-founder, Copprint (IL)
- » 15:05 h Recent development on soluble materials for printed OLEDs
Dr. Junyou Pan, CTO, Zhejiang Brilliant Optoelectronic (CN)
- » 15:25 h Ultra-Precise Printing for Next-Generation Microelectronics
Witold Nawrot, Portfolio Manager, XTPL (PL)
- » 15:45 h Developments in AI to enhance FHE reliability and manufacturing at scale
Wolfgang Mildner, Managing Director Europe, Bayflex (US)
- » 16:05 h Continuous Laser Assisted Deposition (CLAD) - enabling digital PCB manufacturing
Herve Javice, Co-Founder & CEO, I-O-Tech (IL)
- » 16:25 h Printing electronics on paper – How can this be used to manufacture sustainable multilayer printed circuit boards?
Gerhard Domann, Head of Cluster „Application Technology“, Deputy Director of Fraunhofer Innovation Platform „Functional Passive Materials“ FIP-FPM@KU, Fraunhofer ISC (DE)
- » 16:45 h Summary & Adjourn
Raswanth Sendhil Sasikala, Project Manager, OE-A (DE)
- » 16:50 h End

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